

Amendments to the Specification:

Please replace paragraph [0013] with the following amended "set" of paragraphs:

[0013] FIGS. 2-5 illustrate an exemplary application of the above method. FIG. 2 illustrates a substrate 200 that, by way of example, may be a 40 mil lapped alumina ceramic substrate. The substrate 200 comprises a ground plane 204 on a top surface thereof. However, the ground plane might also be on the bottom surface of the substrate, or even interior to the substrate. For purposes of this description, the phrase "ground plane" is intended to cover ground planes that substantially or completely cover a surface, as well as ground traces that function as ground planes with respect to one or more particular conductors.

[0013.1] A dielectric 202 is deposited on the substrate 200 in any of a variety of configurations and, by way of example, may form a long and narrow plateau having a more or less trapezoidal cross-section. See FIG. 3. In one embodiment, the dielectric is the KQ CL-90-7858 dielectric (a glass dielectric) available from Heraeus Cermalloy (24 Union Hill Road, West Conshohocken, Pennsylvania, USA). However, the dielectric may be another dielectric and, particularly, may be another KQ dielectric, glass dielectric, or any other dielectric with suitable electrical properties. The low loss and low dielectric constant of KQ CL-90-7858 makes it particularly suited for building microwave circuits (e.g., microwave transmission lines).